



ANALOGUE DISPLAY MEMBER MADE OF CRYSTALLINE MATERIAL, TIMEPIECE
FITTED THEREWITH AND METHOD FOR FABRICATING THE SAME

The invention concerns an analogue display member such as a timepiece hand.

The invention also concerns a timepiece and a method of fabricating a display member.

5 The fabrication of a hand for use as a display member in a timepiece is particularly complex, in particular when the hand is to be fitted to a top of the range timepiece, for which the hand has to have a particularly polished surface appearance, possibly with facets.

10 Currently, hands are fabricated in brass, steel, gold, aluminium, or in a special alloy. They can be galvanically treated, covered with paint, oxidised or untreated if the material used is gold. They are generally made by machining or die stamping.

However, satisfactory dimensional precision can still not be obtained with the machining and die stamping techniques for these materials, and additional operations of deburring, polishing, etc are required to obtain the final shape of the hand.

15 Moreover, it is generally necessary to apply multiple treatments to the hands to guarantee high quality surface finish.

Further, current hand fabricating techniques do not allow all desired forms to be achieved, thereby curbing the creativity of timepiece designers.

20 It is an object of the present invention to propose a hand that is easier to fabricate while offering great design freedom as to its form, and that can be fabricated in series so as to minimise production costs.

25 The invention thus proposes an analogue display member fitted to a timepiece, of the type comprising a main body in which an arbour hole is arranged, the arbour hole being fitted to a drive arbour, characterized in that the main body is made of silicon based crystalline material. Preferably, the main body of the analogue display member has the shape of a timepiece hand.

The display member according to the invention has the advantage of being able to be easily fabricated using technology proven in microelectronics for fabricating integrated circuits and in micromechanics for fabricating microstructures.

30 Silicon has the advantage of being very light, since its density is approximately 2.49 kg/dm^3 , which minimises the mass of the display member, and thus problems of inertia and unbalance, in particular when it takes the form of a hand. Moreover, the reduction in unbalance and inertia of the display member has a positive influence on the sizing of the display member drive means and on the energy consumption of said
35 drive means.



According to other features of the invention:

- the main body comprises a proximal portion, in which the arbour hole is arranged, and a distal portion which forms the indicator section of the hand, and the distal portion is linked to the proximal portion by at least one beam whose width, in a transverse plane to the arbour, is less than or equal to a hundred microns;
- the main body includes, in the thickness thereof, a multitude of bores which are parallel to the drive arbour and which have a diameter smaller than fifty microns.
- the top surface of the main body includes embossed patterns;
- the top surface of the main body includes facets;
- at least one face of the main body is provided with a coating made of a different material from the main body;
- the coating is made of metal;
- the display member includes at least one integrated circuit element that is arranged in the thickness of the main body;
- the crystalline material is monocrystalline silicon.

The invention also proposes a timepiece characterized in that it includes at least one analogue display member in accordance with one of the preceding features.

The invention further proposes a method of fabricating analogue display members to be fitted to timepieces, each analogue display member comprising a main body in which an arbour hole is arranged, the arbour hole being fitted to a drive arbour, characterized in that it includes at least one step of micro-machining a plate of silicon based crystalline material so as to make at least one main body in said crystalline material with its arbour hole.

This method is easy to implement to mass-produce precise, light pieces.

According to other features of the method according to the invention:

- during the plate micro-machining step, flexible elements are formed on the main body to allow the analogue display member to be mounted on the drive arbour by resilient deformation of the flexible elements;
- the micro-machining step is implemented so as to make several analogue display members simultaneously in the same plate;
- the micro-machining step includes at least one lithographic step for reproducing the contours of at least one portion of the main body of one analogue display member on the plate;
- the method includes at least one step of depositing a coating on at least one face of the main body of each analogue display member;
- the method includes at least one step of micro-machining the top face of the main body in order to form embossed patterns thereon;

- the method includes at least one step of micro-machining the top face of the main body in order to make facets thereon;

- the crystalline material is monocrystalline silicon.

Other features and advantages of the present invention will appear more
5 clearly upon reading the following detailed description, made with reference to the annexed drawings, given by way of non-limiting example and in which:

- Figures 1 to 6 are vertical cross-sections which illustrate schematically several steps of a method of fabricating timepiece hands from a silicon plate in accordance with the teaching of the invention;

10 - Figures 7a and 7b are top views that show schematically the silicon plate at the step illustrated in Figure 6;

- Figure 8 is a top view that shows schematically a watch fitted with at least one hand obtained by the method according to the invention;

15 - Figure 9 is a vertical cross-section that shows schematically a hand obtained by the method according to the invention;

- Figure 10 is a top view that shows schematically a hand obtained by the method according to the invention provided with two longitudinal facets;

- Figure 11 is a vertical cross-section along the cross-sectional plane 11-11 of the hand of Figure 10:

20 - Figure 12 is a top view that shows schematically a hand obtained by the method according to the invention provided with two connecting beams;

- Figure 13 is an enlarged view of a section of beam of Figure 12;

- Figure 14 is an axial cross-section along the plane 14-14 that shows, in an enlarged manner, the distal end portion of the hand of Figure 12.

25 Figures 1 to 7 show several steps of a method for fabricating analogue display members 10 in accordance with the teaching of the invention.

Analogue display members 10 are here hands 10, one example of which is shown schematically in Figure 9.

30 In accordance with the teaching of the invention, each hand 10 includes a main body 11 which is made of silicon based crystalline material.

"Silicon based crystalline material" here means a crystalline material containing silicon such as monocrystalline silicon, polycrystalline silicon and quartz.

Preferably, hand 10 according to the invention is micro-machined in a monocrystalline silicon plate 12 like those that are used to make integrated electronic
35 circuits, such plates being generally called "wafers".

Advantageously, a series of several hands 10 is made in the same silicon wafer 12, in accordance with a method called "batch processing", using techniques

derived from microelectronics which enable mechanical micro-structures to be fabricated in a silicon wafer 12.

These techniques are already implemented for fabricating pressure sensors, accelerometers, micro-actuators, and micro-pumps. They mainly comprise two types
5 of fabricating methods which are dry etching and wet etching.

These methods generally use masking techniques which locally remove a layer of material of a determined thickness.

Dry etching methods use, for example, a laser beam or a high density plasma source.

10 According to a preferred embodiment of the invention, technologies for micro-machining silicon wafer 12 are used so as to make hands 10 directly in the thickness of the silicon wafer.

Electro-polishing is an example of a technique used for silicon etching. This technique uses the property of monocrystalline silicon of being porosified by anodic
15 electrochemical etching in a hydrofluoric acid using a low current density, this technique being able to remove the silicon completely with high current densities.

An example implementation of the silicon electropolishing technique is described in the publication entitled "Electrochemical Fabrication of Multiwalled Micro Channels" by R.W. Tjerkstra et al, pages 133-136 of "Proceedings of Micro Total
20 Analysis Systems 98 Workshop" Banff, Canada, within the scope of the fabrication of coaxial micro channels whose separating walls are made of porous silicon. Reference can be made to this publication, incorporated herein by reference, for more detail on this method.

Other examples of silicon micro-machining methods are described in the work
25 entitled "Fundamentals of microfabrication" by Marc Madou, edited by CRC Press, and bearing the reference ISBN 0-8493-9451-1, incorporated herein by reference, to which reference can be made for further details..

The main steps of the method according to the invention will now be described in a simplified manner.

30 Figure 1 shows a silicon wafer 12 prior to implementation of the method according to the invention.

Figure 2 illustrates a step of depositing a sacrificial layer 14 on the top face of silicon wafer 12.

Figure 3 illustrates the treatment of sacrificial layer 14, through a mask 16, for
35 locally altering the structure of sacrificial layer 14 so as to draw a pattern representing a series of hands 10 on silicon wafer 12.

In Figure 5, silicon wafer 12 has been etched through the sacrificial layer, preferably in accordance with an anisotropic etching technique, such that the pattern representing hands 10 is now drawn in the thickness of silicon wafer 12.

The remaining sacrificial layer 14 is then removed, as shown in Figure 6.

5 A silicon wafer 12, in which hands 10 are pre-cut and remain attached to the body of wafer 12 via bridges of material, is thus obtained, as shown in Figures 7a and 7b.

The final fabrication step of hands 10 consists in detaching the hands from silicon wafer 12.

10 Advantageously, the method according to the invention can comprise at least one step during which a coating, for example of metal, is deposited on the silicon forming hands 10. This coating can be deposited in accordance with chemical vapour deposition or physical vapour deposition techniques.

15 The method according to the invention can also comprise a chemical and/or thermal treatment step applied to the surface of the silicon forming hands 10, for example in order to alter the aspect of the silicon surface.

It should be noted that the etching steps can also be implemented so as to alter the appearance of the silicon surface, or so as to alter the surface appearance of a coating deposited on the silicon, by making geometrical or other patterns, which
20 provides interesting optical effects. Such geometrical patterns may, for example, give a needle etching type appearance to the surface of hands 10 made in the silicon. Such etching steps can be implemented when hands 10 are still carried by silicon wafer 12.

According to the embodiment shown in Figure 9, the top face of hand 10 is
25 provided with embossed geometric patterns 24 which were made by silicon etching. A metal deposition 26 was made on these geometric patterns 24 which gives hand 10 an needle etched metallic external appearance. It should be noted that this result would be very difficult to obtain with a hand 10 whose main body 11 is made of metal.

According to the embodiment shown in Figures 10 and 11, two longitudinal
30 facets 28 have been etched in the top face of hand 10.

Depending upon the embodiments, patterns 24 and facets 28 can have curved profiles so as to form waves in the surface of hand 10.

It should be noted that the method of fabricating hands 10 according to the invention easily allows hands 10 to be made with very varied external appearances.

35 Advantageously, the method according to the invention can be implemented in parallel on several silicon wafers 12, so as to make hands 10 with similar features simultaneously in several silicon wafers 12.

Figure 8 shows a watch 20 which is provided with at least one silicon hand 10 made in accordance with the method according to the invention.

Each hand 10 is to be connected in rotation to an arbour or a wheel of the watch movement (not shown) of watch 20. Hand 10 is thus provided here with an
5 arbour hole 32 to be driven onto a drive arbour 34.

Advantageously, the inner axial surface of arbour hole 32 is provided with a layer 36 of material enabling hand 10 to be driven in by deforming layer 36 or by sliding against layer 36 limiting the risk of breaking main body 11.

According to an alternative embodiment, hand 10 according to the invention
10 can be bonded or welded onto drive arbour 34.

According to an advantageous embodiment of the invention, which is shown in Figure 9, an integrated circuit element 22 is made in the thickness of silicon wafer 12, in the body 11 of hand 10.

Integrated circuit element 22 can be made, in accordance with conventional
15 microelectronic fabrication techniques, before, during or after implementation of the fabrication method according to the invention. Thus, integrated circuit elements 22 can be made beforehand in silicon wafer 12 as shown in Figure 1, from which hands 10 are fabricated.

Integrated circuit element 22 can be electrically connected to the control circuit
20 of watch 20, through the rotational arbour of hand 10.

Integrated circuit element 22 includes, for example, an integrated light emitting diode in the thickness of hand 10. Hand 10 can thus be lit from the inside, by exploiting the transparent properties of silicon.

Integrated circuit element 22 can include a sensor provided for supplying the
25 control circuit of watch 20 with indications as to the angular position of hand 10 in relation to the dial.

Figures 12 to 14 show an improved embodiment in which hand 10 is made entirely of silicon, i.e. its main body 11, which forms the mechanical structure of hand 10, is made of silicon and defines the external shape of hand 10; of course, main body
30 11 can be coated with one or several layers of coatings, such as metallic coatings.

According to the embodiment shown, main body 11 includes an annular proximal portion 38 in which arbour hole 32 is arranged for mounting hand 10 on drive arbour 34 of watch 20. Arbour hole 32 is provided to be fitted onto drive arbour 34, such that hand 10 is fixed onto drive arbour 34 in a manner similar to driving in.

Arbour hole 32 is provided here with flexible elements 40 in the form of
35 tongues that are made in a single piece with the proximal portion 38 of main body 11 and which project onto the inner surface of arbour hole 32. Flexible elements 40 are

provided to deform resiliently when hand 10 is mounted on drive arbour 34. Thus, after assembly, flexible elements 40 exert a gripping force on drive arbour 34 which holds hand 10 axially on drive arbour 34 and connects the two elements in rotation.

Flexible elements 40 are preferably formed during the step of micro-machining silicon wafer 12.

Main body 11 also includes a distal portion 42 which forms the indicator section of hand 10. The distal portion 42 has the form here of a triangle but it could take any other suitable form for indicating a determined angular position on the dial of timepiece 20.

Distal portion 42 is connected to proximal portion 38 by two beams 44, 46 whose width l1, in a transverse plane to drive arbour 34, is comprised between thirty and two hundred microns, and is preferably equal to fifty microns. The width l1 of fifty microns offers a good compromise between rigidity and fineness for beam 44, 46.

One thus obtains a hand 10 of which practically only the proximal portion 38 and the distal portion 42 are visible, when the user of watch 20 consults the indications given by hand 10, in particular in a top view. Indeed, combined with the very small thickness, comprised for example between thirty and a hundred microns, preferably equal to fifty microns, the small width l1 makes beams 44, 46 almost invisible to the naked eye and thus to make the elements underneath hand 10 more visible, between proximal portion 38 and distal portion 42, particularly elements displayed on the dial of watch 20. Moreover, the use of these almost invisible beams 44, 46 offers more freedom in the design of hand 10, by concealing part of the structure of hand 10.

Of course, hand 10 according to the invention can include more than two beams 44, 46. The number of beams 44, 46 could be chosen as a function of the shape of hand 10, particularly as a function of the shape of distal portion 42, in order to ensure sufficient rigidity and shock resistance for hand 10.

Figure 13, which is an enlarged view of a beam 46 of Figure 12, it can be seen that beams 46 can be provided with recesses 48 which are arranged in a suitable manner to lighten the structure of hand 10 without significantly penalising its rigidity and shock resistance. Recesses 48 are formed here of apertures or windows which are aligned and distributed over the length of beam 46 defining bridges of material between the two parallel parts forming beam 46.

Advantageously, as can be seen in Figure 14, main body 11 of hand 10 includes, in its axial thickness, a multitude of generally cylindrical bores 50 which are substantially parallel to drive arbour 34 and which have a diameter smaller than fifty microns, preferably a diameter comprised between three and ten microns. The object

of these bores 50 is to reduce the unbalance and inertia of hand 10. Since the mass of the beams has very little influence on the unbalance and inertia of hand 10, bores 50 are preferably arranged only in distal portion 42, but they could also be arranged in the other parts of main body 11.

Bores 50 here pass through the entire thickness of main body 11. they have sufficiently small dimensions to be invisible to the naked eye for the user of watch 20, such that they do not adversely affect the aesthetic appearance of hand 10.

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CLAIMS

1. Analogue display member (10) fitted to a timepiece (20), of the type including a main body (11) in which an arbour hole (32) is made, said arbour hole (32) being fitted to a drive arbour (34), characterized in that the main body (11) is made of a silicon based crystalline material.
- 5 2. Analogue display member (10) according to claim 1, characterized in that the main body (11) has the shape of a timepiece hand (10).
3. Analogue display member (10) according to the preceding claim, characterized in that the main body (11) includes a proximal portion (38), in which the arbour hole (32) is arranged, and a distal portion (42) which forms the indicator
10 section of the hand (10), and in that the distal portion (42) is connected to the proximal portion (38) by at least one beam (44, 46) whose width, in a transverse plane to the arbour (34), is comprised between thirty and two hundred microns.
4. Analogue display member (10) according to any of the preceding claims, characterized in that the main body (11) includes, in the thickness thereof, a multitude
15 of bores (50) which are parallel to the drive arbour (34) and which have a diameter smaller than fifty microns.
5. Analogue display member (10) according to any of the preceding claims, characterized in that the main body (11) includes flexible elements (40) which are made in a single piece with the rest of the main body (11) and which extend into the
20 arbour hole (32) so as to allow the analogue display member (10) to be fitted onto the drive arbour (34) via resilient deformation of the flexible elements (40).
6. Analogue display member (10) according to any of the preceding claims, characterized in that the top surface of the main body (11) includes embossed patterns (24).
- 25 7. Analogue display member (10) according to any of the preceding claims, characterized in that the top surface of the main body (11) includes facets (28).
8. Analogue display member (10) according to any of the preceding claims, characterized in that at least one face of the main body (11) is provided with a coating (26) made in a different material from the main body (11).
- 30 9. Analogue display member (10) according to the preceding claim, characterized in that the coating (26) is made of metal.
10. Analogue display member (10) according to any of the preceding claims, characterized in that it includes at least one integrated circuit element (22) which is arranged in the thickness of the main body (11).

11. Analogue display member (10) according to any of the preceding claims, characterized in that the crystalline material is monocrystalline silicon.

12. Timepiece (20) characterized in that it includes at least one analogue display member (10) according to any of the preceding claims.

5 13. Method of fabricating analogue display members (10) to be fitted to timepieces (20), each analogue display member (10) including a main body (11) in which an arbour hole (32) is arranged, the arbour hole (32) being fitted to a drive arbour (34), characterized in that it includes at least one step of micro-machining a wafer (12) of silicon based crystalline material to make at least one main body (11) in
10 said crystalline material with said arbour hole (32).

14. Fabrication method according to the preceding claim, characterized in that, during the wafer (12) micro-machining step, flexible elements (40) are formed on the main body (11) to allow assembly of the analogue display member (10) on the drive arbour (34) via the resilient deformation of the flexible elements (40).

15 15. Fabrication method according to claim 13 or 14, characterized in that the micro-machining step is implemented so as to make several analogue display members (10) simultaneously in the same wafer (12).

16. Fabrication method according to any of claims 13 to 15, characterized in that the micro-machining step includes at least one lithographic step for reproducing
20 on said wafer (12) the contours of at least one portion of the main body (11) of one analogue display member (10).

17. Fabrication method according to any of claims 13 to 16, characterized in that it includes at least one step of depositing a coating (26) on at least one face of the main body (11) of each analogue display member (10).

25 18. Fabrication method according to any of claims 13 to 17, characterized in that it includes at least one step of micro-machining the top face of the main body (11) to form embossed patterns (24) therein.

19. Fabrication method according to any of claims 13 to 17, characterized in that it includes at least one step of micro-machining the top face of the main body (11)
30 to form facets (28) therein.

20. Fabrication method according to any of claims 13 o 19, characterized in that the crystalline material is monocrystalline silicon.